

<b>PATENT ASSIGNMENT COVER SHEET</b>
--------------------------------------

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT7201754

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	SECURITY INTEREST
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
QUIP NYC INC.	02/11/2022
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	JPMORGAN CHASE BANK, N.A.
<b>Street Address:</b>	10 SOUTH DEARBORN, FLOOR L2, IL1-1145
<b>City:</b>	CHICAGO
<b>State/Country:</b>	ILLINOIS
<b>Postal Code:</b>	60603
<b>PROPERTY NUMBERS Total: 18</b>	
<b>Property Type</b>	<b>Number</b>
Patent Number:	D762986
Patent Number:	10792136
Application Number:	16263802
Application Number:	29750484
Application Number:	63078138
Application Number:	16128065
Application Number:	16518394
Application Number:	17062275
Application Number:	29750489
Application Number:	63078172
Application Number:	29724800
Application Number:	29766809
Application Number:	29711898
Application Number:	17361042
Application Number:	29739588
Application Number:	63140208
Application Number:	29767349
Patent Number:	D908964
<b>CORRESPONDENCE DATA</b>	

**Fax Number:** (617)523-6850

***Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.***

**Phone:** 617-523-2700

**Email:** susan.dinicola@hkllaw.com

**Correspondent Name:** HOLLAND & KNIGHT LLP

**Address Line 1:** 10 ST. JAMES AVENUE

**Address Line 4:** BOSTON, MASSACHUSETTS 02116

<b>ATTORNEY DOCKET NUMBER:</b>	088499.01511
--------------------------------	--------------

<b>NAME OF SUBMITTER:</b>	SUSAN C. DINICOLA
---------------------------	-------------------

<b>SIGNATURE:</b>	/Susan C. DiNicola/
-------------------	---------------------

<b>DATE SIGNED:</b>	03/01/2022
---------------------	------------

**Total Attachments: 4**

source=JPMorgan\_Quip - IP Notice#page1.tif

source=JPMorgan\_Quip - IP Notice#page2.tif

source=JPMorgan\_Quip - IP Notice#page3.tif

source=JPMorgan\_Quip - IP Notice#page4.tif

## Notice of Grant of Security Interest in U.S. Patents and Trademarks

To: United States Patent and Trademark Office

Date: February 11, 2022

Ladies and Gentlemen:

Please be advised that pursuant to that certain (i) Credit Agreement dated as of the date first written above (as the same may be amended, modified, extended or restated from time to time, the "*Credit Agreement*") by and among Quip NYC Inc., a Delaware corporation ("*Borrower*"), the other Loan Parties (as defined in the Credit Agreement) from time to time party thereto and JPMorgan Chase Bank, N.A. (the "*Lender*"), and (ii) Security Agreement, dated as of the date first written above (as amended, restated, supplemented or modified from time to time, the "*Security Agreement*"), among the Loan Parties, as Grantors, and the Lender, the undersigned have granted a continuing security interest in and to, and Lien (as defined in the Credit Agreement) upon, all right, title, and interest in the trademarks and patents shown below to the Lender and requests same be recorded against the trademarks and patents shown below:

### TRADEMARKS

DESCRIPTION	SERIAL NUMBER
QUIP (word mark) US Class 035	86347741
QUIP (word mark) US Class 021	86977206
QUIP (word mark) US Class 003	86977211
QUIP (word mark) US Class 044	87438740
QUIP (word mark) US Class 003	87771606
QUIP (word mark) US Class 021	87771607
QUIP (word mark) US Class 021	87983203
QUIP (stylized logo) US Classes 003, 021, 035, and 044	87983227
QUIP (stylized logo) US Class 003	87983860
QUIPCARE (word mark) US Classes 009 and 035	88567860
QUIPCARE+ (word mark) US Classes 009 and 035	88567864

**PATENTS**

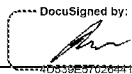
<b>FILING DATE</b>	<b>APPLICATION NUMBER</b>	<b>ISSUE DATE</b>	<b>PATENT NUMBER</b>
28-Oct-2013	29/470,874	09-Aug-2016	D762,986
31-Jan-2019	16/263,802		
14-Sep-2020	29/750,484		
14-Sep-2020	63/078,138		
11-Sep-2018	16/128,065		
24-Oct-2014	14/522,805	06-Oct-2020	10,792,136
22-Jul-2019	16/518,394		
02-Oct-2020	17/062,275		
14-Sep-2020	29/750,489		
14-Sep-2020	63/078,172		
19-Feb-2020	29/724,800		
16-Sep-2019	29/705,864	26-Jan-2021	D908,964
19-Jan-2021	29/766,809		
04-Nov-2019	29/711,898		
28-Jun-2021	17/361,042		
26-Jun-2020	29/739,588		
21-Jan-2021	63/140,208		
21-Jan-2021	29/767,349		

[remainder of page intentionally left blank]

The undersigned and the Lender hereby acknowledge and agree that the security interest in the foregoing may only be terminated in accordance with the terms of the Credit Agreement and Security Agreement.

Very truly yours,

**QUIP NYC INC.,**  
a Delaware corporation

By:  \_\_\_\_\_  
Name: Simon Enever  
Title: Chief Executive Officer

Acknowledged and Accepted:

**JPMORGAN CHASE BANK, N.A.,**  
as Lender

By: \_\_\_\_\_  
Name: \_\_\_\_\_  
Title: Authorized Officer

The undersigned and the Lender hereby acknowledge and agree that the security interest in the foregoing may only be terminated in accordance with the terms of the Credit Agreement and Security Agreement.

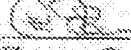
Very truly yours,

**QUIP NYC INC.,**  
a Delaware corporation

By: \_\_\_\_\_  
Name: \_\_\_\_\_  
Title: \_\_\_\_\_

Acknowledged and Accepted:

**JPMORGAN CHASE BANK, N.A.,**  
as Lender

By:  \_\_\_\_\_  
Name: Thomas G. Williams  
Title: Authorized Officer

[If Notice]